



# PHPT61006PY

100 V, 6 A PNP high power bipolar transistor

21 January 2015

Product data sheet

## 1. General description

PNP high power bipolar transistor in a SOT669 (LFAK56) Surface-Mounted Device (SMD) power plastic package.

NPN complement: PHPT61006NY

## 2. Features and benefits

- High thermal power dissipation capability
- High temperature applications up to 175 °C
- Reduced Printed Circuit Board (PCB) requirements comparing to transistors in DPAK
- High energy efficiency due to less heat generation
- AEC-Q101 qualified.

## 3. Applications

- Power management
- Load switch
- Linear mode voltage regulator
- Backlighting applications
- Motor drive
- Relay replacement

## 4. Quick reference data

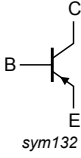
Table 1. Quick reference data

| Symbol      | Parameter                               | Conditions                                                                                            | Min | Typ | Max  | Unit       |
|-------------|-----------------------------------------|-------------------------------------------------------------------------------------------------------|-----|-----|------|------------|
| $V_{CEO}$   | collector-emitter voltage               | open base                                                                                             | -   | -   | -100 | V          |
| $I_C$       | collector current                       |                                                                                                       | -   | -   | -6   | A          |
| $I_{CM}$    | peak collector current                  | $t_p \leq 1$ ms; single pulse                                                                         | -   | -   | -12  | A          |
| $R_{CEsat}$ | collector-emitter saturation resistance | $I_C = -6$ A; $I_B = -600$ mA; $t_p \leq 300$ $\mu$ s; $\delta \leq 0.02$ ; $T_{amb} = 25$ °C; pulsed | -   | 85  | 270  | m $\Omega$ |

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5. Pinning information

Table 2. Pinning information

| Pin | Symbol | Description | Simplified outline                                                                                                   | Graphic symbol                                                                      |
|-----|--------|-------------|----------------------------------------------------------------------------------------------------------------------|-------------------------------------------------------------------------------------|
| 1   | E      | emitter     |  <p>LFPAK56; Power-SO8 (SOT669)</p> |  |
| 2   | E      | emitter     |                                                                                                                      |                                                                                     |
| 3   | E      | emitter     |                                                                                                                      |                                                                                     |
| 4   | B      | base        |                                                                                                                      |                                                                                     |
| mb  | C      | collector   |                                                                                                                      |                                                                                     |

6. Ordering information

Table 3. Ordering information

| Type number | Package            |                                                                            |         |
|-------------|--------------------|----------------------------------------------------------------------------|---------|
|             | Name               | Description                                                                | Version |
| PHPT61006PY | LFPAK56; Power-SO8 | Plastic single-ended surface-mounted package (LFPAK56; Power-SO8); 4 leads | SOT669  |

7. Marking

Table 4. Marking codes

| Type number | Marking code |
|-------------|--------------|
| PHPT61006PY | 1006PAB      |

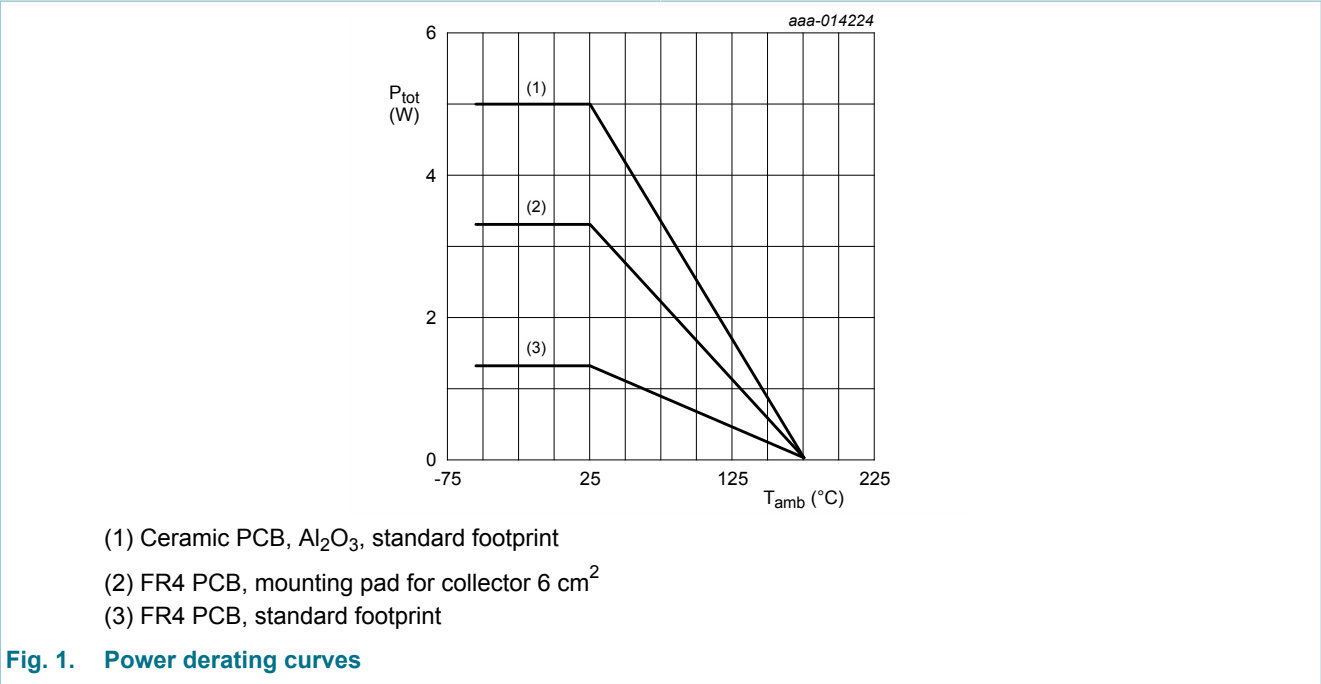
## 8. Limiting values

**Table 5. Limiting values**

*In accordance with the Absolute Maximum Rating System (IEC 60134).*

| Symbol    | Parameter                 | Conditions                    |     | Min | Max  | Unit |
|-----------|---------------------------|-------------------------------|-----|-----|------|------|
| $V_{CBO}$ | collector-base voltage    | open emitter                  |     | -   | -100 | V    |
| $V_{CEO}$ | collector-emitter voltage | open base                     |     | -   | -100 | V    |
| $V_{EBO}$ | emitter-base voltage      | open collector                |     | -   | -8   | V    |
| $I_C$     | collector current         |                               |     | -   | -6   | A    |
| $I_{CM}$  | peak collector current    | $t_p \leq 1$ ms; single pulse |     | -   | -12  | A    |
| $I_B$     | base current              |                               |     | -   | -1   | A    |
| $I_{BM}$  | peak base current         | $t_p \leq 1$ ms; pulsed       |     | -   | -2   | A    |
| $P_{tot}$ | total power dissipation   | $T_{amb} \leq 25$ °C          | [1] | -   | 1.3  | W    |
|           |                           |                               | [2] | -   | 3.3  | W    |
|           |                           |                               | [3] | -   | 5    | W    |
|           |                           |                               | [4] | -   | 25   | W    |
| $T_j$     | junction temperature      |                               |     | -   | 175  | °C   |
| $T_{amb}$ | ambient temperature       |                               |     | -55 | 175  | °C   |
| $T_{stg}$ | storage temperature       |                               |     | -65 | 175  | °C   |

- [1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.
- [2] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated mounting pad for collector 6 cm<sup>2</sup>.
- [3] Device mounted on an ceramic Printed-Circuit Board (PCB), Al<sub>2</sub>O<sub>3</sub>, standard footprint.
- [4] Power dissipation from junction to mounting base.

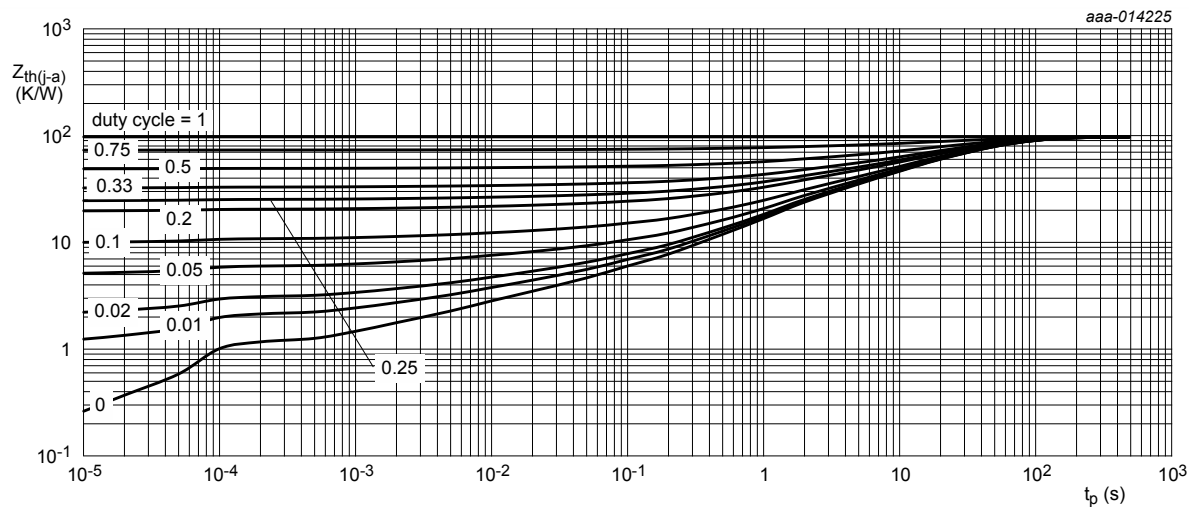


9. Thermal characteristics

Table 6. Thermal characteristics

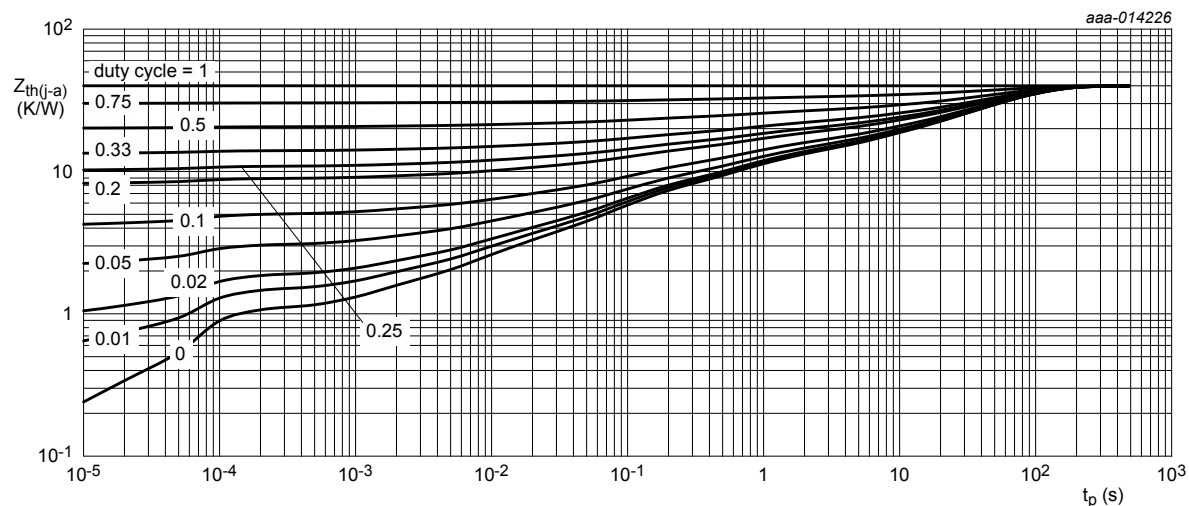
| Symbol                | Parameter                                         | Conditions  |     | Min | Typ | Max | Unit |
|-----------------------|---------------------------------------------------|-------------|-----|-----|-----|-----|------|
| R <sub>th(j-a)</sub>  | thermal resistance from junction to ambient       | in free air | [1] | -   | -   | 115 | K/W  |
|                       |                                                   |             | [2] | -   | -   | 45  | K/W  |
|                       |                                                   |             | [3] | -   | -   | 30  | K/W  |
| R <sub>th(j-mb)</sub> | thermal resistance from junction to mounting base |             |     | -   | -   | 6   | K/W  |

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.  
[2] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for collector 6 cm<sup>2</sup>.  
[3] Device mounted on an ceramic Printed-Circuit Board (PCB), Al<sub>2</sub>O<sub>3</sub>, standard footprint.



FR4 PCB, standard footprint

Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



FR4 PCB, mounting pad for collector 6 cm<sup>2</sup>

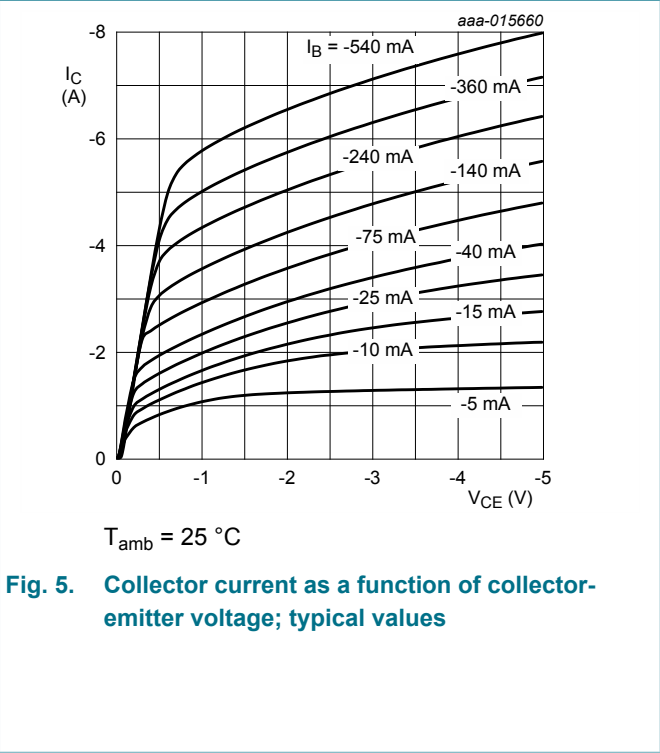
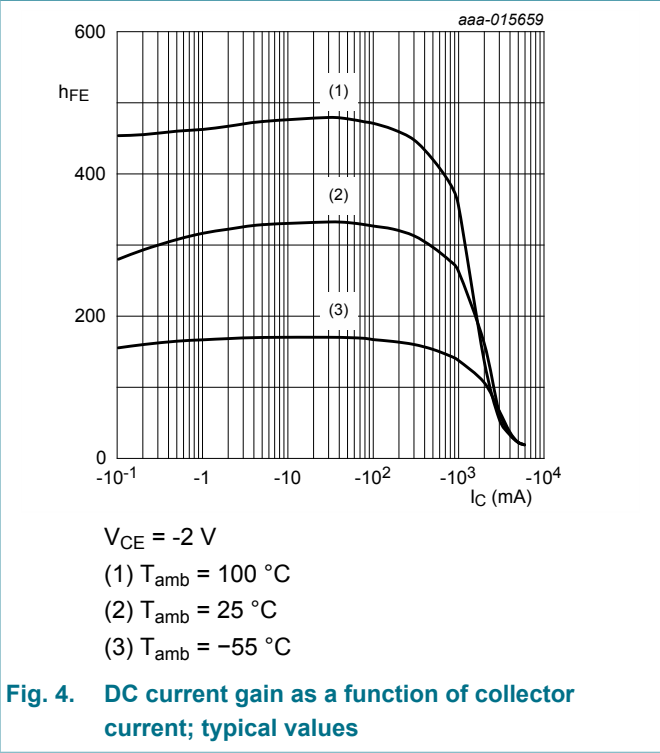
Fig. 3. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

## 10. Characteristics

Table 7. Characteristics

| Symbol      | Parameter                               | Conditions                                                                                                                                             | Min | Typ   | Max   | Unit          |
|-------------|-----------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------|-----|-------|-------|---------------|
| $I_{CBO}$   | collector-base cut-off current          | $V_{CB} = -80 \text{ V}; I_E = 0 \text{ A}; T_{amb} = 25 \text{ }^{\circ}\text{C}$                                                                     | -   | -     | -100  | nA            |
|             |                                         | $V_{CB} = -80 \text{ V}; I_E = 0 \text{ A}; T_j = 150 \text{ }^{\circ}\text{C}$                                                                        | -   | -     | -50   | $\mu\text{A}$ |
| $I_{CES}$   | collector-emitter cut-off current       | $V_{CE} = -80 \text{ V}; V_{BE} = 0 \text{ V}; T_{amb} = 25 \text{ }^{\circ}\text{C}$                                                                  | -   | -     | -100  | nA            |
| $I_{EBO}$   | emitter-base cut-off current            | $V_{EB} = -8 \text{ V}; I_C = 0 \text{ A}; T_{amb} = 25 \text{ }^{\circ}\text{C}$                                                                      | -   | -     | -100  | nA            |
| $h_{FE}$    | DC current gain                         | $V_{CE} = -2 \text{ V}; I_C = -500 \text{ mA}; T_{amb} = 25 \text{ }^{\circ}\text{C}$                                                                  | 170 | 305   | -     |               |
|             |                                         | $V_{CE} = -2 \text{ V}; I_C = -1 \text{ A}; t_p \leq 300 \text{ } \mu\text{s}; \delta \leq 0.02; T_{amb} = 25 \text{ }^{\circ}\text{C}; \text{pulsed}$ | 160 | 275   | -     |               |
|             |                                         | $V_{CE} = -2 \text{ V}; I_C = -3 \text{ A}; t_p \leq 300 \text{ } \mu\text{s}; \delta \leq 0.02; T_{amb} = 25 \text{ }^{\circ}\text{C}; \text{pulsed}$ | 45  | 90    | -     |               |
|             |                                         | $V_{CE} = -2 \text{ V}; I_C = -6 \text{ A}; \text{pulsed}; t_p \leq 300 \text{ } \mu\text{s}; \delta \leq 0.02; T_{amb} = 25 \text{ }^{\circ}\text{C}$ | 10  | 20    | -     |               |
| $V_{CEsat}$ | collector-emitter saturation voltage    | $I_C = -1 \text{ A}; I_B = -50 \text{ mA}; t_p \leq 300 \text{ } \mu\text{s}; \delta \leq 0.02; T_{amb} = 25 \text{ }^{\circ}\text{C}$                 | -   | -75   | -130  | mV            |
|             |                                         | $I_C = -3 \text{ A}; I_B = -300 \text{ mA}; \text{pulsed}; t_p \leq 300 \text{ } \mu\text{s}; \delta \leq 0.02; T_{amb} = 25 \text{ }^{\circ}\text{C}$ | -   | -150  | -240  | mV            |
|             |                                         | $I_C = -6 \text{ A}; I_B = -600 \text{ mA}; \text{pulsed}; t_p \leq 300 \text{ } \mu\text{s}; \delta \leq 0.02; T_{amb} = 25 \text{ }^{\circ}\text{C}$ | -   | -900  | -1600 | mV            |
| $R_{CEsat}$ | collector-emitter saturation resistance | $I_C = -6 \text{ A}; I_B = -600 \text{ mA}; t_p \leq 300 \text{ } \mu\text{s}; \delta \leq 0.02; T_{amb} = 25 \text{ }^{\circ}\text{C}; \text{pulsed}$ | -   | 85    | 270   | m $\Omega$    |
| $V_{BEsat}$ | base-emitter saturation voltage         | $I_C = -1 \text{ A}; I_B = -50 \text{ mA}; \text{pulsed}; t_p \leq 300 \text{ } \mu\text{s}; \delta \leq 0.02; T_{amb} = 25 \text{ }^{\circ}\text{C}$  | -   | -0.8  | -0.95 | V             |
|             |                                         | $I_C = -3 \text{ A}; I_B = -300 \text{ mA}; \text{pulsed}; t_p \leq 300 \text{ } \mu\text{s}; \delta \leq 0.02; T_{amb} = 25 \text{ }^{\circ}\text{C}$ | -   | -0.95 | -1.1  | V             |
|             |                                         | $I_C = -6 \text{ A}; I_B = -600 \text{ mA}; \text{pulsed}; t_p \leq 300 \text{ } \mu\text{s}; \delta \leq 0.02; T_{amb} = 25 \text{ }^{\circ}\text{C}$ | -   | -1.1  | -1.25 | V             |
| $V_{BEon}$  | base-emitter turn-on voltage            | $V_{CE} = -2 \text{ V}; I_C = -500 \text{ mA}; T_{amb} = 25 \text{ }^{\circ}\text{C}$                                                                  | -   | -0.7  | -0.8  | V             |
| $t_d$       | delay time                              | $V_{CC} = -12.5 \text{ V}; I_C = -3 \text{ A}; I_{Bon} = -150 \text{ mA}; I_{Boff} = 150 \text{ mA}; T_{amb} = 25 \text{ }^{\circ}\text{C}$            | -   | 15    | -     | ns            |
| $t_r$       | rise time                               |                                                                                                                                                        | -   | 220   | -     | ns            |
| $t_{on}$    | turn-on time                            |                                                                                                                                                        | -   | 235   | -     | ns            |
| $t_s$       | storage time                            |                                                                                                                                                        | -   | 160   | -     | ns            |
| $t_f$       | fall time                               |                                                                                                                                                        | -   | 185   | -     | ns            |
| $t_{off}$   | turn-off time                           |                                                                                                                                                        | -   | 345   | -     | ns            |

| Symbol | Parameter             | Conditions                                                                                                                         | Min | Typ | Max | Unit |
|--------|-----------------------|------------------------------------------------------------------------------------------------------------------------------------|-----|-----|-----|------|
| $f_T$  | transition frequency  | $V_{CE} = -10\text{ V}$ ; $I_C = -500\text{ mA}$ ;<br>$f = 100\text{ MHz}$ ; $T_{amb} = 25\text{ }^{\circ}\text{C}$                | -   | 116 | -   | MHz  |
| $C_c$  | collector capacitance | $V_{CB} = -10\text{ V}$ ; $I_E = 0\text{ A}$ ; $i_e = 0\text{ A}$ ;<br>$f = 1\text{ MHz}$ ; $T_{amb} = 25\text{ }^{\circ}\text{C}$ | -   | 52  | -   | pF   |



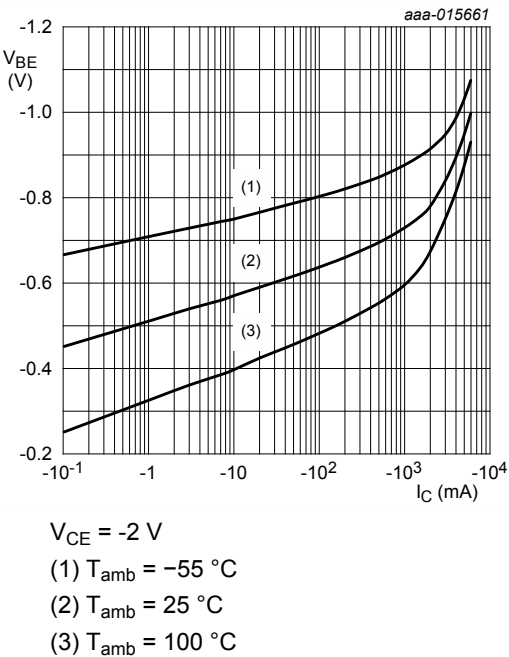


Fig. 6. Base-emitter voltage as a function of collector current; typical values

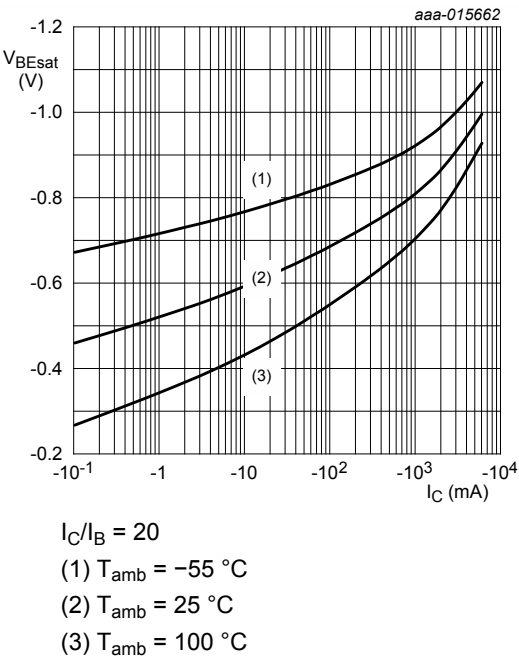


Fig. 7. Base-emitter saturation voltage as a function of collector current; typical values

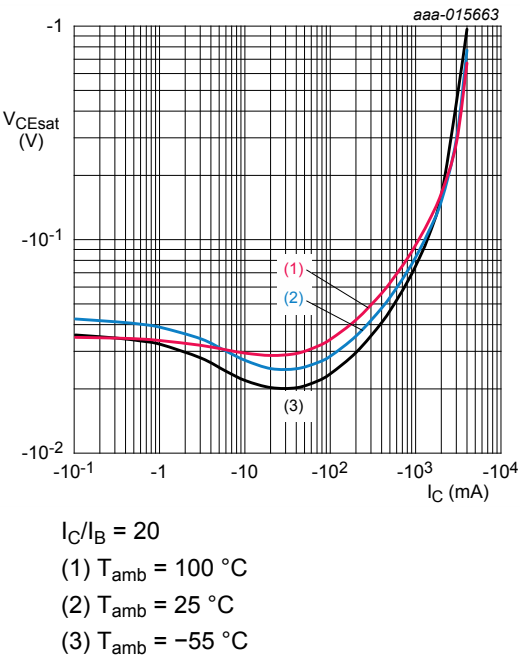


Fig. 8. Collector-emitter saturation voltage as a function of collector current; typical values

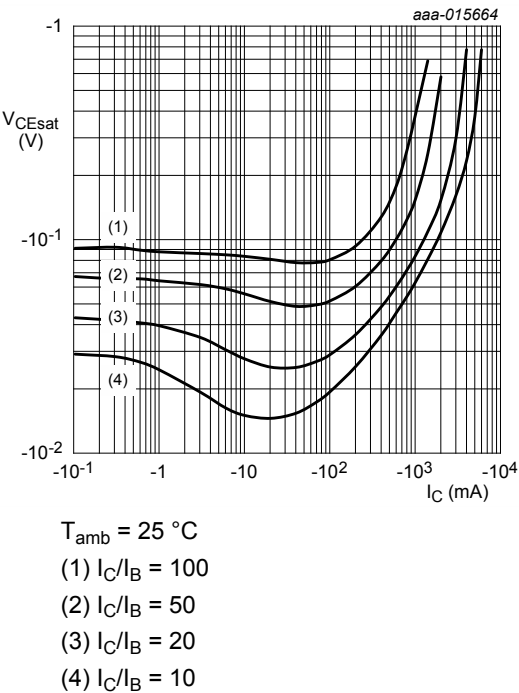


Fig. 9. Collector-emitter saturation voltage as a function of collector current; typical values

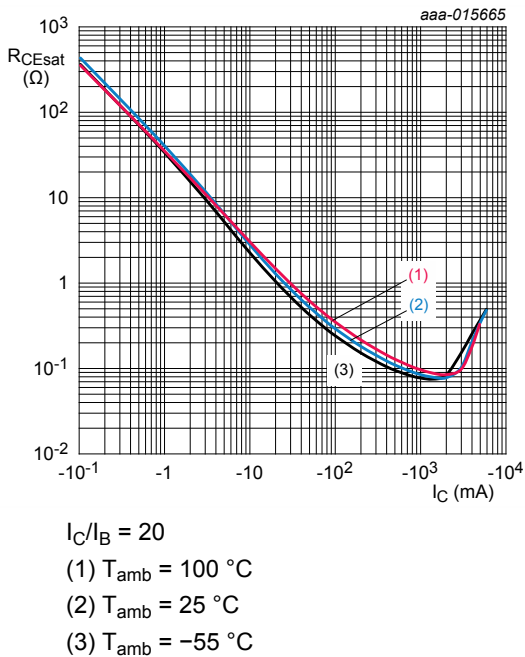


Fig. 10. Collector-emitter saturation resistance as a function of collector current; typical values

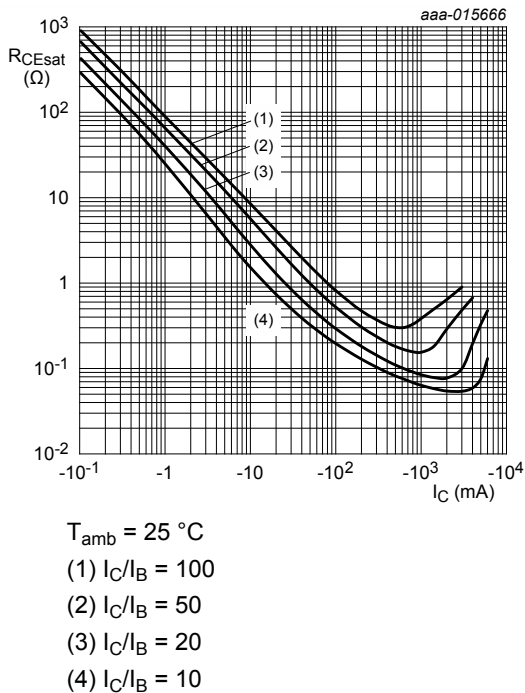


Fig. 11. Collector-emitter saturation resistance as a function of collector current; typical values

11. Test information

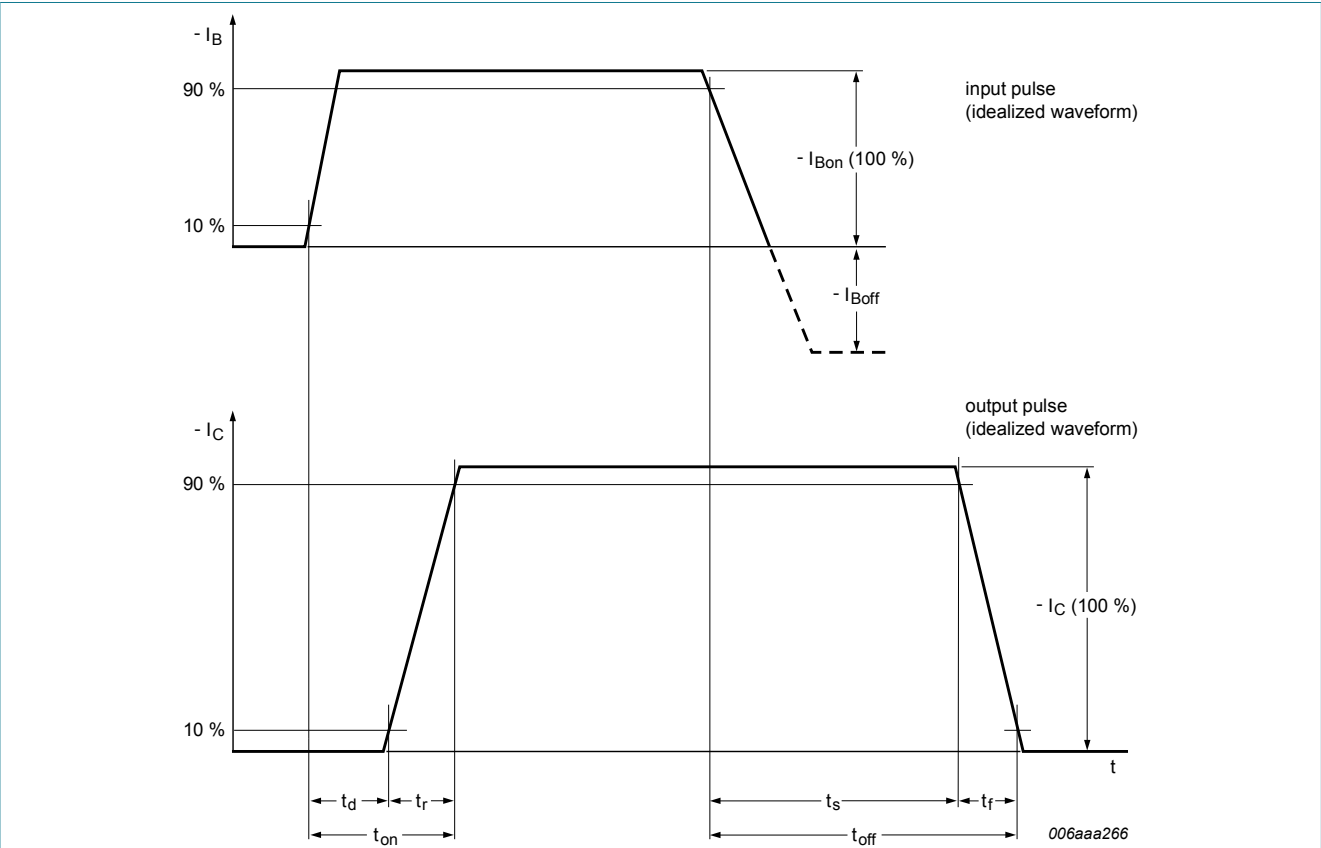


Fig. 12. BISS transistor switching time definition

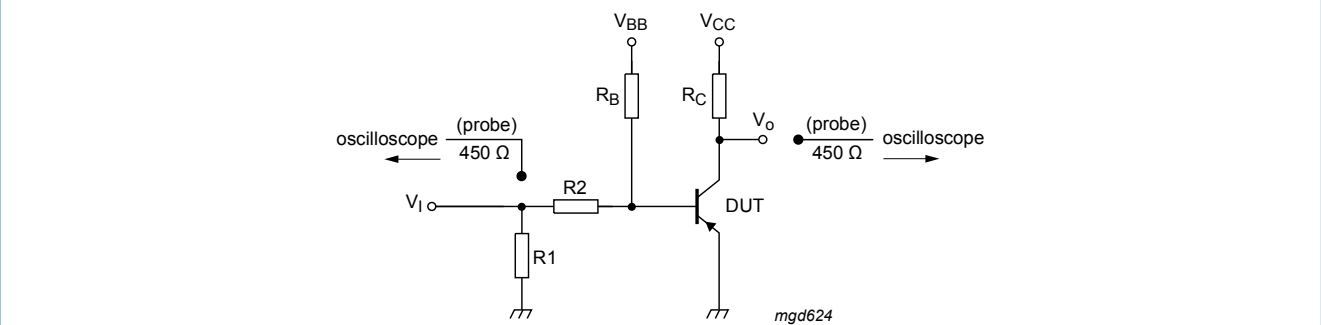


Fig. 13. Test circuit for switching times

11.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

12. Package outline

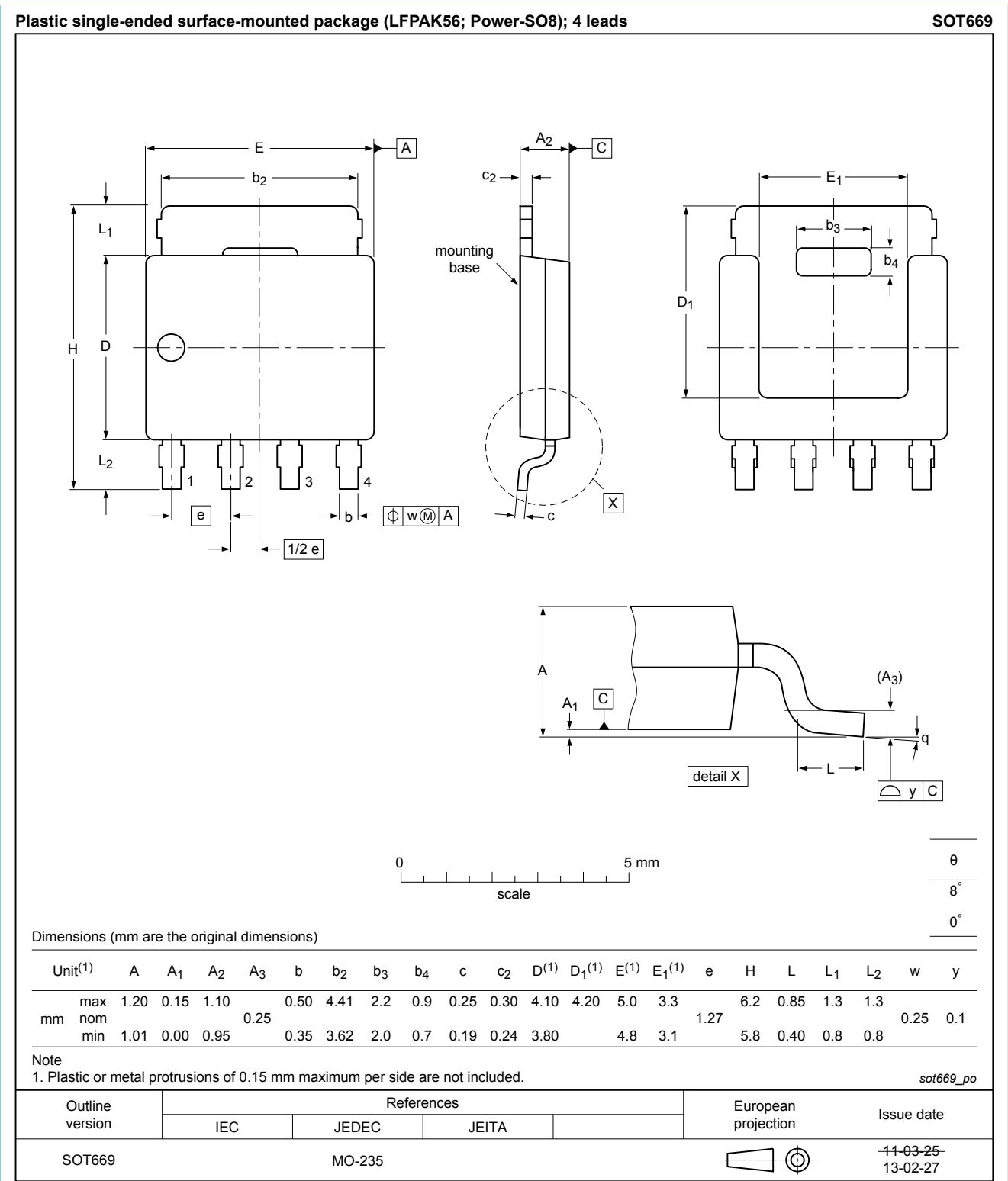
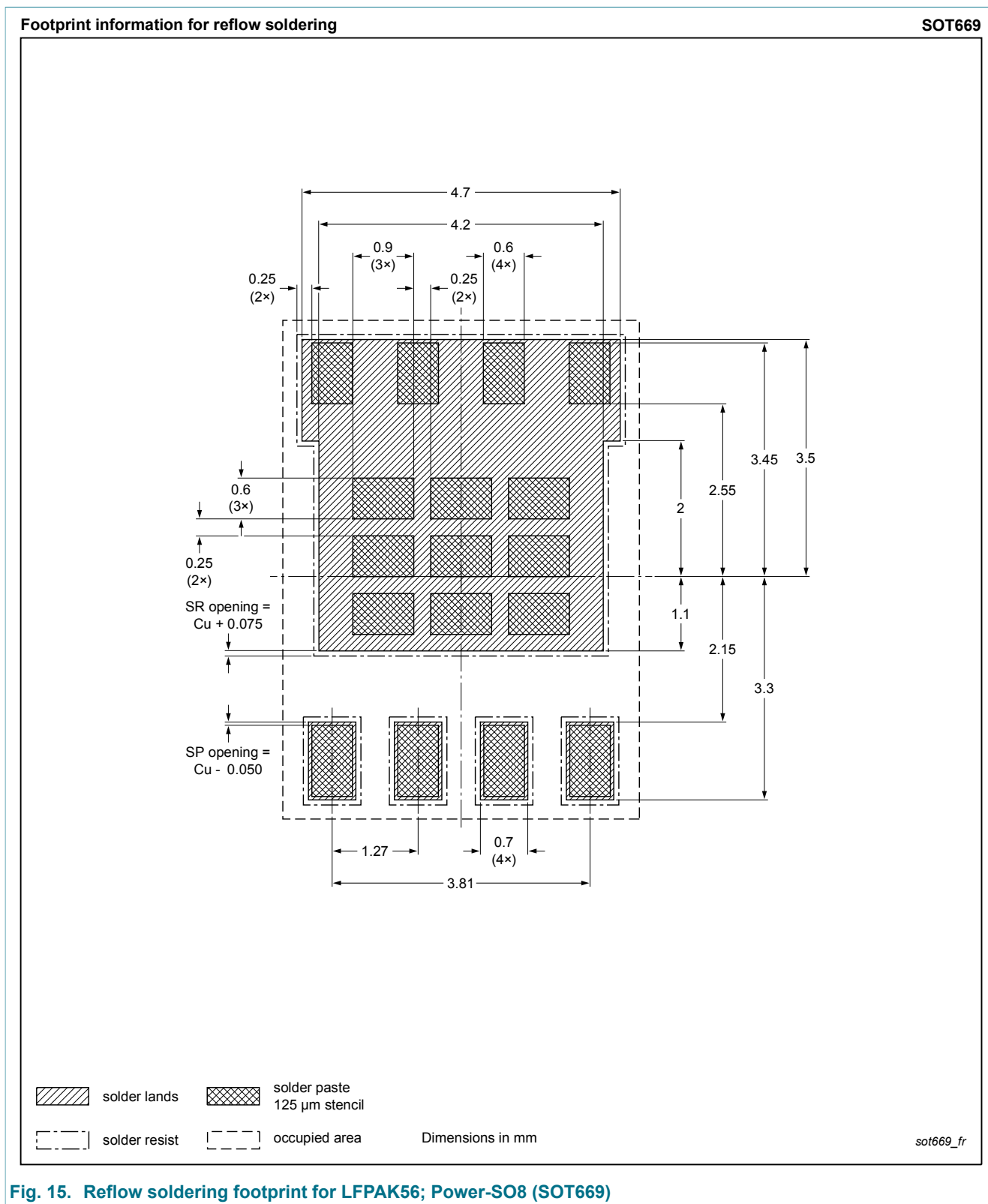


Fig. 14. Package outline LPAK56; Power-SO8 (SOT669)

## 13. Soldering



**Fig. 15. Reflow soldering footprint for LPAK56; Power-SO8 (SOT669)**

14. Revision history

Table 8. Revision history

| Data sheet ID   | Release date | Data sheet status  | Change notice | Supersedes |
|-----------------|--------------|--------------------|---------------|------------|
| PHPT61006PY v.1 | 20150121     | Product data sheet | -             | -          |

## 15. Legal information

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| Document status [1][2]         | Product status [3] | Definition                                                                            |
|--------------------------------|--------------------|---------------------------------------------------------------------------------------|
| Objective [short] data sheet   | Development        | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification      | This document contains data from the preliminary specification.                       |
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16. Contents

1 General description ..... 1

2 Features and benefits ..... 1

3 Applications ..... 1

4 Quick reference data ..... 1

5 Pinning information ..... 2

6 Ordering information ..... 2

7 Marking ..... 2

8 Limiting values ..... 3

9 Thermal characteristics ..... 4

10 Characteristics ..... 6

11 Test information ..... 10

11.1 Quality information ..... 10

12 Package outline ..... 11

13 Soldering ..... 12

14 Revision history ..... 13

15 Legal information ..... 14

15.1 Data sheet status ..... 14

15.2 Definitions ..... 14

15.3 Disclaimers ..... 14

15.4 Trademarks ..... 15

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Date of release: 21 January 2015

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